

Description

40V N-CHANNEL ENHANCEMENT MODE POWER MOSFET

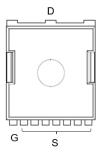
Features

- Device Rating V_{DS} = 40V, I_D = 537A
- $R_{DS(ON)} = 0.45 \text{m}\Omega$ (typ.) @ $V_{GS} = 10 \text{V}$, $I_D = 100 \text{A}$
- Advanced Split Gate Device Design
- RoHS Compliant & Halogen-Free
- Qualified according to JEDEC for target applications
- 100% avalanche test

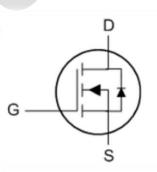
Application

- · High frequency synchronous rectifiers
- Brushless DC motor control
- Battery protection
- High performance DC/DC converters
- OR-ing and redundant power switches

Package







Absolute Maximum Ratings T_C=25℃ unless otherwise specified

Symbol	Parameter		Max.	Units
V _{DS}	Drain-Source Voltage		40	V
V _G S	Gate-Source Voltage		± 20	V
ID	Continuous Drain Current, VGS @ 10V note1	T _C = 25°C	537	Α
		T _C = 100°C	340	Α
I _{DM}	Pulsed Drain Current note2		TBD	Α
P _D	Power Dissipation note4	T _C = 25°C	312	W
	Power Dissipation	T _A = 25°C	3.1	W
Eas	Single Pulsed Avalanche Energy note3		TBD	mJ
Rejc	Thermal Resistance, Junction to Case note1		0.4	°C/W
R _θ JA	Junction to Ambient (mounted on 1 inch square PCB)		40	°C/W
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C

Electrical Characteristics Tc=25°C unless otherwise specified



JFG537N40Q

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Charac	cteristic					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0V, I _D = 250μA	40	-	-	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} = 40V, V _{GS} = 0V, T _C = 25°C	-	-	1	μA
		V _{DS} = 40V, V _{GS} = 0V, T _C = 55°C	-	-	10	μA
Igss	Gate-Source Leakage Current	V _{DS} = 0V, V _{GS} = ±20V	-100	-	100	nA
On Charac	cteristics					•
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1	-	2.4	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10V, I _D =100A	-	0.45	0.6	mΩ
		V _{GS} = 4.5V, I _D =50A	- <	0.55	0.7	mΩ
g FS	Forward Transconductance	V _{DS} = 10V, I _D =100A	_	TBD	-	S
Dynamic (Characteristics					
Rg	Gate Resistance		- /-	TBD	-	Ω
C _{iss}	Input Capacitance	V _{DS} = 20V, V _{GS} = 0V, f = 1MHz	-	22000	-	pF
Coss	Output Capacitance		-	4982	-	pF
Crss	Reverse Transfer Capacitance	2	_	247	-	pF
Qg	Total Gate Charge	V _{DS} =20V, I _D = 100A, V _{GS} = 4.5V	-	TBD	-	nC
Qg	Total Gate Charge	150 1101	-	317	-	nC
Qgs	Gate-Source Charge	V_{DS} =20V, I_{D} = 100A, V_{GS} = 10V	-	64	-	nC
Q _{gd}	Gate-Drain("Miller") Charge	VG3 10V	-	46	-	nC
Switching	Characteristics					I.
t _{d(on)}	Turn-On Delay Time		-	TBD	-	ns
tr	Turn-On Rise Time	$V_{DD} = 20V, I_D = 30A,$ $R_G = 1\Omega, V_{GS} = 4.5V$	-	TBD	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	TBD	-	ns
t _f	Turn-Off Fall Time		-	TBD	-	ns
Source-Dr	rain Diode Characteristics and Maxin	num Ratings				
Is	Maximum Continuous Diode Forward Current note1,5		-	-	208	Α
Іѕм	Maximum Pulsed Diode Forward Current note2,5		-	-	TBD	Α
t _{rr}	Reverse Recovery Time	T _J = 25°C, V _R = 34V, I _F = 100A,	-	TBD	-	ns
Q _{rr}	Reverse Recovery Charge	di/dt = 100A/µs	-	TBD	-	nC
V _{SD} note2	Source to Drain Diode Forward Voltage	T _J = 25°C, I _S = 100A, V _{GS} = 0V	-	0.8	ı	V

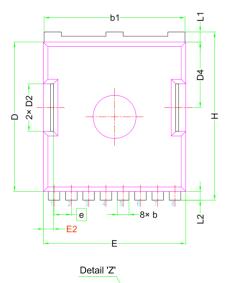
Note:

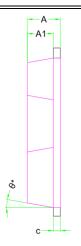
- 1.The data tested by surface mounted on one inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed, pulse width \leq 300us, duty cycle \leq 2%.
- 3.The EAS data shows Max. rating. The test condition is L=0.1mH, IAS= TBD A.
- 4.The power dissipation is limited by 150 $^{\circ}\text{C}\,$ junction temperature.
- 5.The data is theoretically the same as l_D and l_{DM} , in real applications, should be limited by total power dissipation.

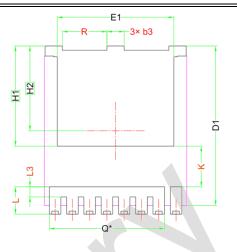
Package outline



JFG537N40Q



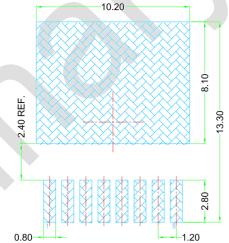








Detail 'Z'



NOTE:

- 1. REFER TO JEDEC MO-299B.
- 2. All DIMENSIONS ARE IN mm, ANGLES IN DEGREES.
 3. DIMENSIONS DO NOT INCLUSIVE BURRS AND MOLD FLASH.
 4. "*" IS FOR REFERENCE.

DIMENSIONS			
MIN.	NOM.	MAX.	
2.20	2.30	2.40	
1.70	1.80	1.90	
0.70	0.80	0.90	
9.70	9.80	9.90	
1.10	1.20	1.30	
0.40	0.50	0.60	
10.28	10.38	10.48	
10.98	11.08	11.18	
3.20	3.30	3.40	
4.45	4.55	4.65	
9.80	9.90	1 0.00	
8.00	8.10	8.20	
0.60	0.70	0.80	
1.20 BSC			
	2.20 1.70 0.70 9.70 1.10 0.40 10.28 10.98 3.20 4.45 9.80 8.00 0.60	2.20 2.30 1.70 1.80 0.70 0.80 9.70 9.80 1.10 1.20 0.40 0.50 10.28 10.38 10.98 11.08 3.20 3.30 4.45 4.55 9.80 9.90 8.00 8.10 0.60 0.70	

SYMBOL	DIMENSIONS				
S I MBOL	MIN.	NOM.	MAX.		
Н	11.58	11.68	11.78		
H1	6.95 BSC				
H2	5.89 BSC				
i	0.10 REF.				
j	0.46 REF.				
K	2.80 REF.				
L	1.40	1.90	2.10		
L1	0.60	0.70	0.80		
L2	0.50	0.60	0.70		
L3	0.30	0.70	0.80		
N	8				
Q	8.00 REF.				
R	3.00	3.10	3.20		
θ	10° REF.				

Figure 19. TOLL Package outline





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